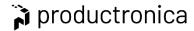


Printed Electronics Insights – Free seminars by OE-A, Nov. 19/20, 2025



Flexible and Printed Electronics: Applications and technologies

Date: Wednesday, November 19, Time: 2025 14:15 - 16:30 h

Venue: Innovation Forum, Hall B2.441

Moderation: Dr. Klaus Hecker, Managing Director, OE-A

»	14:15 h	Introduction to Printed Electronics Dr. Klaus Hecker, Managing Director, OE-A (DE)
»	14:25 h	Printed Electronics – current applications and future trends Dr. Alain Schumacher, CTO, IEE (LU)
»	14:45 h	Manufacturing and applications of large-area LED foils Dr. Ashok Sridhar, CEO & Co-founder, TracXon (NL)

- » 15:05 h Hybrid electronics compared to conventional PCBs: their advantages and challenges Jonas Deitschun, Head of Department Advanced Printing Technologies, Fraunhofer IFAM (DE)
- » 15:25 h Pilot services for supporting and accelerating flexible electronics R&D Prof. Jukka Hast, Research Manager, VTT (FI)
- » 15:45 h Debonding on demand tapes for rework, repair, and recycling in electronics
 Tom Schümchen, Innovation Manager, Lohmann (DE)
- » 16:05 h Empowering Scalable Innovation in Functional Surfaces Fabien Resweber, Business Development Manager, Armor Smart Films (FR)
- » 16:25 h Summary & Adjourn Dr. Klaus Hecker, Managing Director, OE-A (DE)
- » 16:30 h End

For more information visit the OE-A / LOPEC in hall B2, booth 453 and discover the world of flexible and printed electronics.

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Printed Electronics Insights – Free seminars by OE-A, Nov. 19/20, 2025



Flexible and Printed Electronics: Materials, processes and reliability

Date: Thursday, November 20, 2025

Time: 14:15 - 16:50 h

» 16:50 h End

Venue: Innovation Forum, Hall B2.441

Moderation: Raswanth Sendhil Sasikala, Project Manager, OE-A

»	14:15 h	Introduction to Printed Electronics Raswanth Sendhil Sasikala, Project Manager, OE-A (DE)
»	14:25 h	Functionalizing 3D parts with precision: pad printing as a scalable alternative manufacturing technology Anna Ryzhova, Business Development Manager EIMEA, Henkel (DE)
»	14:45 h	Rebuilding the EU PCB industry by moving from chemical etching to additive printing of copper inks Dr. Ofer Shochet, CEO & Co-founder, Copprint (IL)
»	15:05 h	Recent development on soluble mateirals for printed OLEDs Dr. Junyou Pan, CTO, Zhejiang Brilliant Optoelectronic (CN)
»	15:25 h	Ultra-Precise Printing for Next-Generation Microelectronics Witold Nawrot, Portfolio Manager, XTPL (PL)
»	15:45 h	Developments in AI to enhance FHE reliability and manufacturing at scale Wolfgang Mildner, Managing Director Europe, Bayflex (US)
»	16:05 h	Continuous Laser Assisted Deposition (CLAD) - enabling digital PCB manufacturing Herve Javice, Co-Founder & CEO, I-O-Tech (IL)
»	16:25 h	Printing electronics on paper – How can this be used to manufacture sustainable multilayer printed circuit boards? Gerhard Domann, Head of Cluster "Application Technology", Deputy Director of Fraunhofer Innovation Platform "Functional Passive Materials" FIP-FPM@KU, Fraunhofer ISC (DE)
»	16:45 h	Summary & Adjourn Raswanth Sendhil Sasikala, Project Manager, OE-A (DE)

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